

03-16-01

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PATENT
LDC-MASK

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

The Commissioner of Patents and Trademarks
Washington, D.C. 20231Transmittal Letter

Submitted herewith for filing is a patent application of Paul D. Hammesfahr et al for REDUCING POLYMERIZATION STRESS BY CONTROLLED SEGMENTAL CURING, including an unexecuted Declaration.

The fee due is calculated as follows:

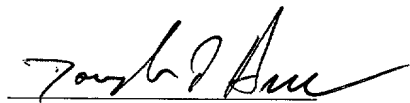
The filing fee is calculated as follows:

Basic Filing Fee		\$ 710.00
Total Claims	25 - 20 = 5 x 18 =	\$ 90.00
Independent Claims	13 - 3 = 10 x 80 =	\$ 800.00
Total filing fee		<u>\$1,160.00</u>

Please charge the fee due for filing in the amount of \$1,600.00 to Deposit Account 04-0780.

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Respectfully submitted,



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March 15, 2001
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J1002 U.S. PTO
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03/15/01
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Date of Mailing by EXPRESS MAIL March 15, 2001

The patent application for LDC-MASK mailed by EXPRESS MAIL on March 15, 2001.




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